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May 2014



# Dual N-Channel PowerTrench<sup>®</sup> MOSFET Q1: 30V, 16A, 21.5m $\Omega$ Q2: 30V, 18A, 13m $\Omega$

# Features

#### Q1: N-Channel

- Max r<sub>DS(on)</sub> = 21.5mΩ at V<sub>GS</sub> = 10V, I<sub>D</sub> = 7.5A
- Max r<sub>DS(on)</sub> = 29.5mΩ at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 6.5A

#### Q2: N-Channel

- Max  $r_{DS(on)}$  = 13m $\Omega$  at V<sub>GS</sub> = 10V, I<sub>D</sub> = 10A
- Max  $r_{DS(on)}$  = 17m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 8.5A
- Low Qg high side MOSFET
- Low r<sub>DS(on)</sub> low side MOSFET
- Thermally efficient dual Power 56 package
- Pinout optimized for simple PCB design
- RoHS Compliant



# **General Description**

This device includes two specialized MOSFETs in a unique dual Power 56 package. It is designed to provide an optimal Synchronous Buck power stage in terms of efficiency and PCB utilization. The low switching loss "High Side" MOSFET is complemented by a Low Conduction Loss "Low Side" SyncFET.

4 D1

3 D1

2 D1

1 G1

# Applications

Synchronous Buck Converter for:

Notebook System Power

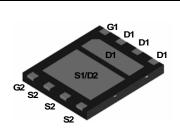
S2 5

S2 6

G2 [8

S2 | 7

General Purpose Point of Load



Power 56

# MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Paramete	r		Q1	Q2	Units
V <sub>DS</sub>	Drain to Source Voltage			30	30	V
V <sub>GS</sub>	Gate to Source Voltage			±20	±20	V
I <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25°C		16	18	
	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	7.5	10	Α
	-Pulsed			60	60	
D	Power Dissipation for Single Operation	T <sub>A</sub> = 25°C	(Note 1a)	2.	.5	14/
P <sub>D</sub>		T <sub>A</sub> = 25°C	(Note 1b)	1		W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperatur	e Range		-55 to	+150	°C

# **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	8.2	3.1	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	a)	50	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	p) 1	20	

# Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS9620S	FDMS9620S	Power 56	13"	12mm	3000 units

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V	Q1 Q2	30 30			V
∆BV <sub>DSS</sub>	Breakdown Voltage Temperature	$I_D = 100$ , $V_{GS} = 00$ $I_D = 250\mu$ A, referenced to 25°C	Q1	50	23		
ΔΒV <sub>DSS</sub> ΔΤ <sub>J</sub>	Coefficient	$I_{D}^{-}$ = 1mA, referenced to 25°C	Q2		23		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V	Q1 Q2			1 500	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	Q1 Q2			±100 ±100	nA
On Chara	cteristics	-	-		r		
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$ $V_{GS} = V_{DS}, I_D = 1 m A$	Q1 Q2	1	1.6 1.6	3	V
AV co (#L)	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $D = 100$	01	•	-4	5	

GS(th)	Cale to Cource Thicshold Voltage	$V_{GS} = V_{DS}, I_D = 1mA$	Q2	1	1.6	3	v
$\frac{\Delta V_{GS(th)}}{\Delta T_{,l}}$	Gate to Source Threshold Voltage	I <sub>D</sub> = 250μA, referenced to 25°C	Q1		-4		mV/°C
$\Delta T_{J}$	Temperature Coefficient	I <sub>D</sub> = 1mA, referenced to 25°C	Q2		-4		IIIV/ C
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 7.5A			18	21.5	
	Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6.5A	Q1		23	29.5	
r		$V_{GS}$ = 10V, $I_D$ = 7.5A , $T_J$ = 125°C			25	32	mΩ
r <sub>DS(on)</sub>	Drain to Source On Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A			9	13	1115.2
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 8.5A	Q2		13	17	
		$V_{GS}$ = 10V, $I_D$ = 10A , $T_J$ = 125°C			14	22	
a	Forward Transconductance	V <sub>DD</sub> = 10V, I <sub>D</sub> = 7.5A	Q1		25		S
9 <sub>FS</sub>		V <sub>DD</sub> = 10V, I <sub>D</sub> = 10A	Q2		27		3

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance		Q1 Q2	500 700	665 935	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1MHZ	Q1 Q2	100 500	135 665	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		Q1 Q2	65 100	100 150	pF
Rg	Gate Resistance	f = 1MHz	Q1 Q2	0.9 1.8		Ω

# **Switching Characteristics**

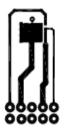
t <sub>d(on)</sub>	Turn-On Delay Time		Q1 Q2	11 15	20 27	ns
t <sub>r</sub>	Rise Time		Q1 Q2	7 13	14 24	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$\frac{V_{\text{DD}} = 15\text{V, I}_{\text{D}} = 1\text{A,}}{V_{\text{GS}} = 10\text{V, R}_{\text{GEN}} = 6\Omega}$	Q1 Q2	23 27	37 44	ns
t <sub>f</sub>	Fall Time		Q1 Q2	2.3 7	10 14	ns
Qg	Total Gate Charge	Q1 V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V ,I <sub>D</sub> = 7.5A	Q1 Q2	10 18	14 25	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	Q2	Q1 Q2	1.7 2.8		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V ,I <sub>D</sub> = 10A	Q1 Q2	2.0 3.6		nC

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-Sou	urce Diode Characteristics						
I <sub>S</sub>	Maximum Continuous Drain-Source Dio	de Forward Current	Q1 Q2			2.1 3.5	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.1A$ (Note 2) $V_{GS} = 0V, I_S = 3.5A$ (Note 2)	Q1 Q2		0.7 0.5	1.2 1.0	V
t <sub>rr</sub>	Reverse Recovery Time	Q1 I <sub>F</sub> = 7.5A, di/dt = 100A/µs	Q1 Q2		13 14		ns
Q <sub>rr</sub>	Reverse Recovery Charge	Q2 Ι <sub>F</sub> = 10A, di/dt = 300A/μs	Q1 Q2		4 9		nC

Notes:
**1:** R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

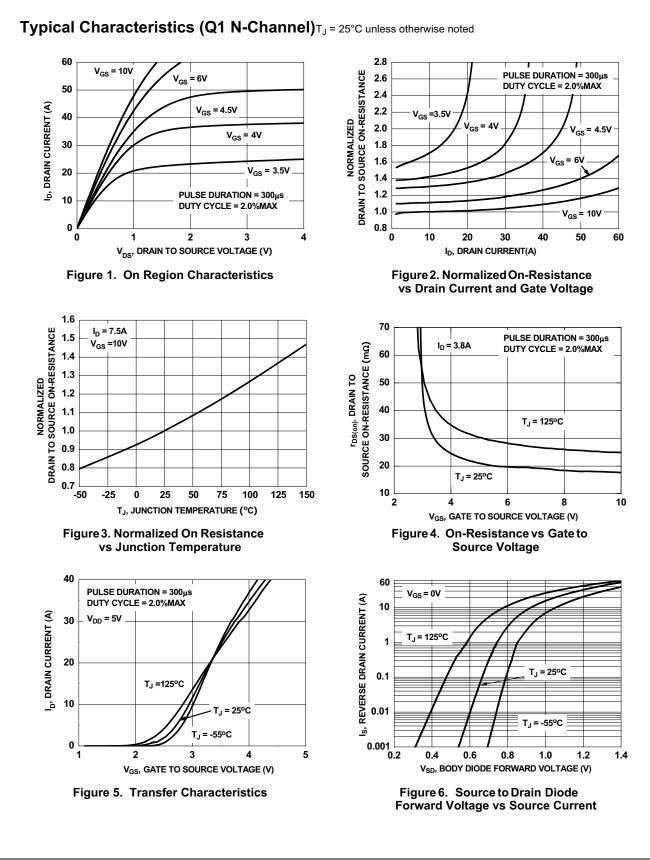


a.50°C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



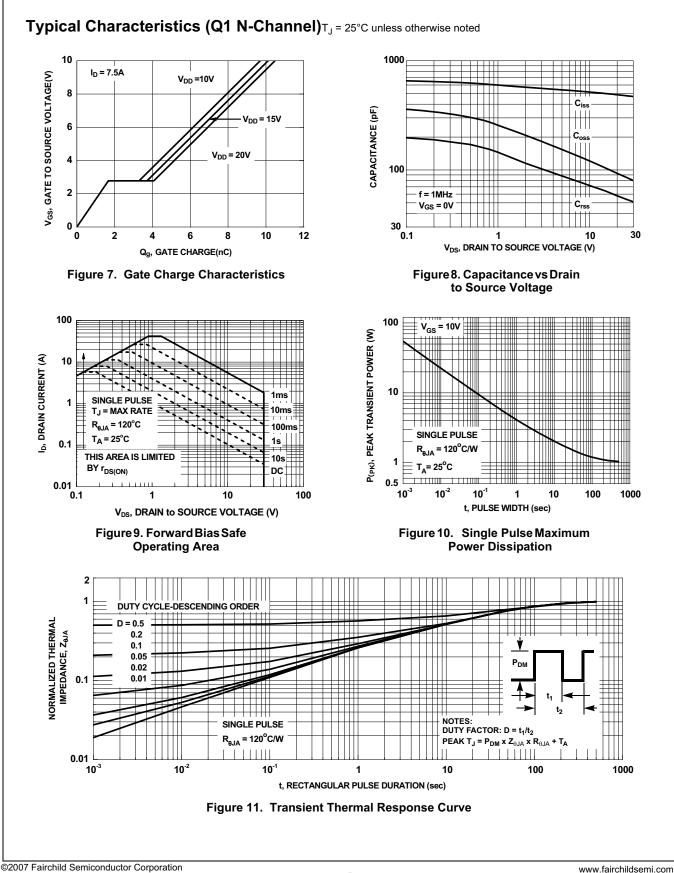
b. 120°C/W when mounted on a minimum pad of 2 oz copper

**2:** Pulse Test: Pulse Width <  $300\mu$ s, Duty cycle < 2.0%.



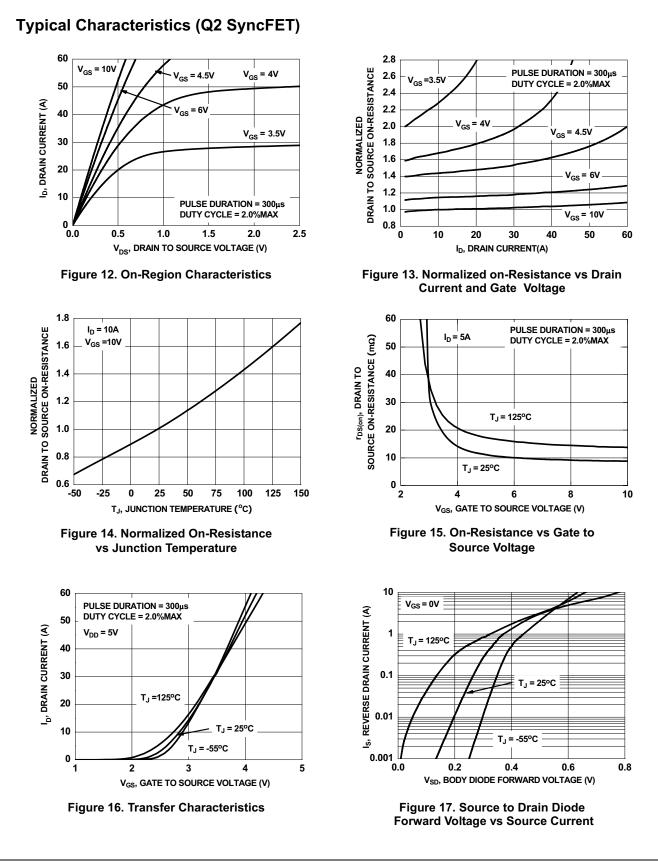
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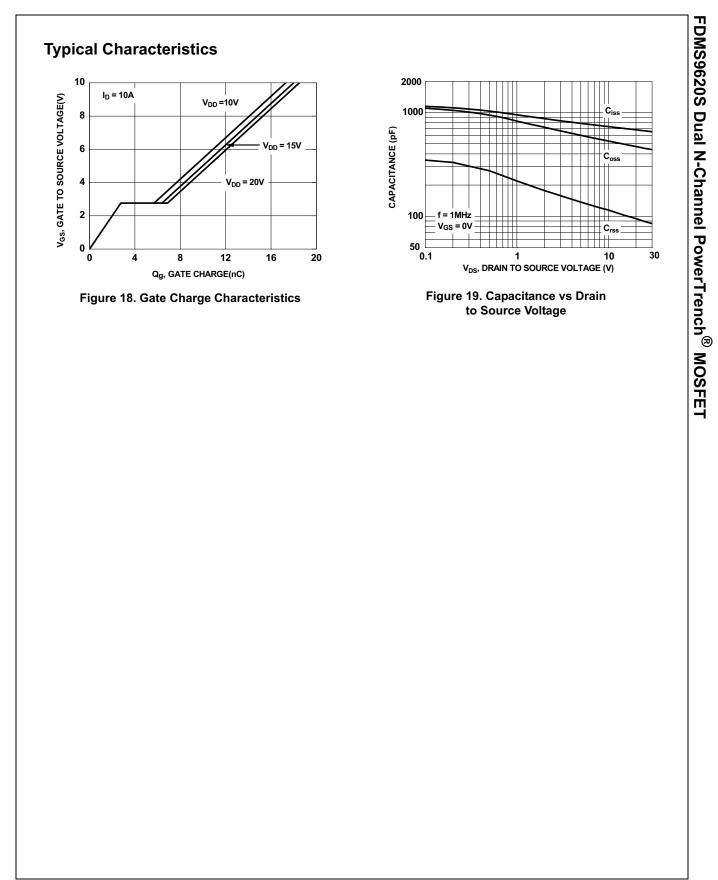
FDMS9620S Dual N-Channel PowerTrench<sup>®</sup> MOSFET

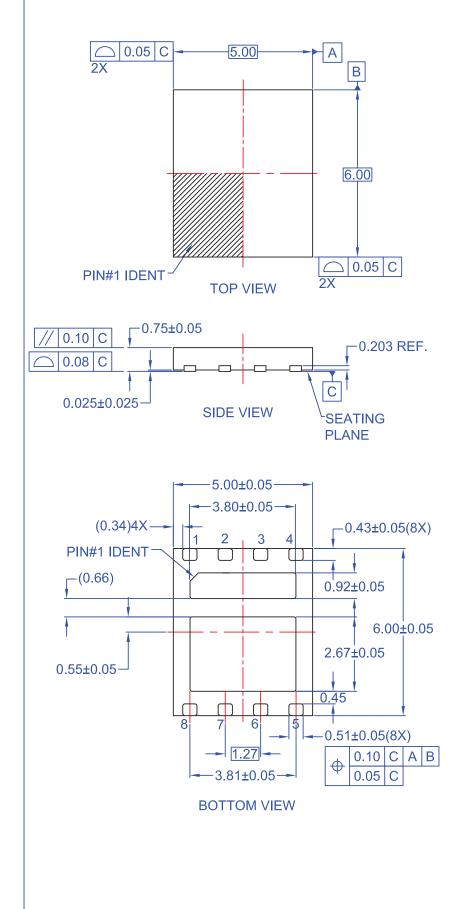
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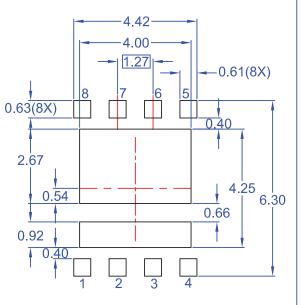


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FDMS9620S Dual N-Channel PowerTrench<sup>®</sup> MOSFET







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NOTE:

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- B. DIMENSIONS ARE IN MILLIMETERS.
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